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H8/300H Tiny Series

Counting Interrupts Generated by Timer Z 16-Bit Free-Running Function

Introduction

The free-running counter function of timer Z is used to count timer Z interrupts. The processing ends when the number of timer Z interrupts reaches 50.

Target Device

H8/3687

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1. Specifications

1. The free-running counter function of timer Z is used to count timer Z interrupts. The processing ends when the number of timer Z interrupts reaches 50.
2. If the timer counter (TCNT0) overflows, a timer Z overflow interrupt request is issued.
3. An 8-bit counter that is placed in RAM is decremented in the timer Z interrupt processing. When the number of timer interrupts reaches 50, the timer Z interrupt is disabled and the processing ends.
4. A timer Z interrupt is specified to be generated every 32.768 ms where the timer counter (TCNT0) overflow occurs.

2. Description of Functions

1. In this sample task, the timer Z free-running counter function is used to count the number of timer Z interrupts. Figure 2.1 is a block diagram of timer Z free-running counter function. The elements of the block diagram are described below.
 - The system clock (ϕ) is a 16-MHz clock that is used as a reference clock for operating the CPU and peripheral functions.
 - Prescaler S (PSS) is a 13-bit counter with clock input of ϕ . PSS is incremented every cycle.
 - Timer control register 0 (TCR0) selects the input clock for TCNT0 and the condition of clearing TCNT0. In this sample task, input clock is specified as $\phi/8$, the counter value is incremented on the rising edge of the clock, and clearing of TCNT0 is disabled.
 - Timer status register 0 (TSR0) indicates the timer Z status. In this sample task, the overflow flag (OVF) is set to 1 when TCNT0 overflows.
 - Timer interrupt enable register (TIER0) enables or disables various interrupt requests. In this sample task, interrupts generated by TCNT0 overflow is enabled and other interrupts are disabled.
 - Timer counter 0 (TCNT0) is a 16-bit readable/writable counter that is incremented by an internal or external clock input. In this sample task, the TCNT0 counter increases on the rising edge of $\phi/8$ and clearing of TCNT0 is disabled.
 - Timer start register (TSTR) starts or stops TCNT0 and TCNT1 operations. In this sample task, TCNT0 is set to start counting and TCNT1 is set to stop counting.
 - Timer mode register (TMDR) selects whether TCNT0 and TCNT1 operate in synchronization. In this sample task, TCNT0 operates independently of TCNT1.

The TCNT0 overflow cycle in this sample task is calculated by the following equation:

$$\text{TCNT0 overflow cycle} = \frac{1}{\text{System clock} / 8} \times 65536 = 32.768 \text{ ms}$$

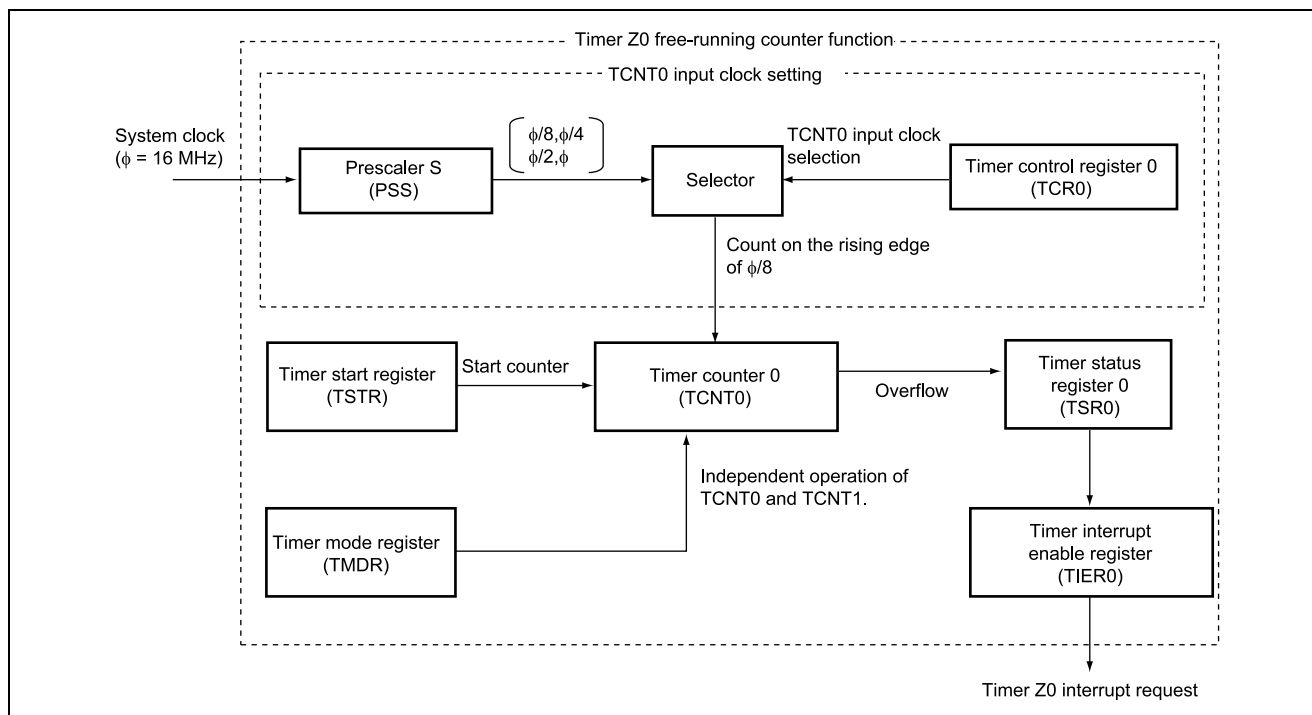


Figure 2.1 Block Diagram of Timer Z0 Free-Running Counter Function

- Table 2.1 lists the function allocation for this sample task. The functions listed in table 2.1 are allocated so that the number of interrupts is counted by the timer Z's free-running counter function.

Table 2.1 Function Allocation

Function	Description
PSS	13-bit counter with system clock input
TCR0	Specifies the input clock for TCNT0.
TSR0	Controls the TCNT0 overflow flag.
TIER0	Enables interrupt requests by TCNT0 overflow.
TCNT0	16-bit counter that is incremented on the rising edge of $\phi/8$ clock.
TSTR	Starts or stops counting by TCNT0.
TMDR	Specifies TCNT0 to operate independently of TCNT1.
counter	8-bit counter that counts the number of timer Z interrupts up to 50.

3. Description of Operation

Operation of this sample task is described in figure 3.1. The hardware and software processing is applied as shown in figure 3.1 to count the number of interrupts by using the free-running counter function of timer Z.

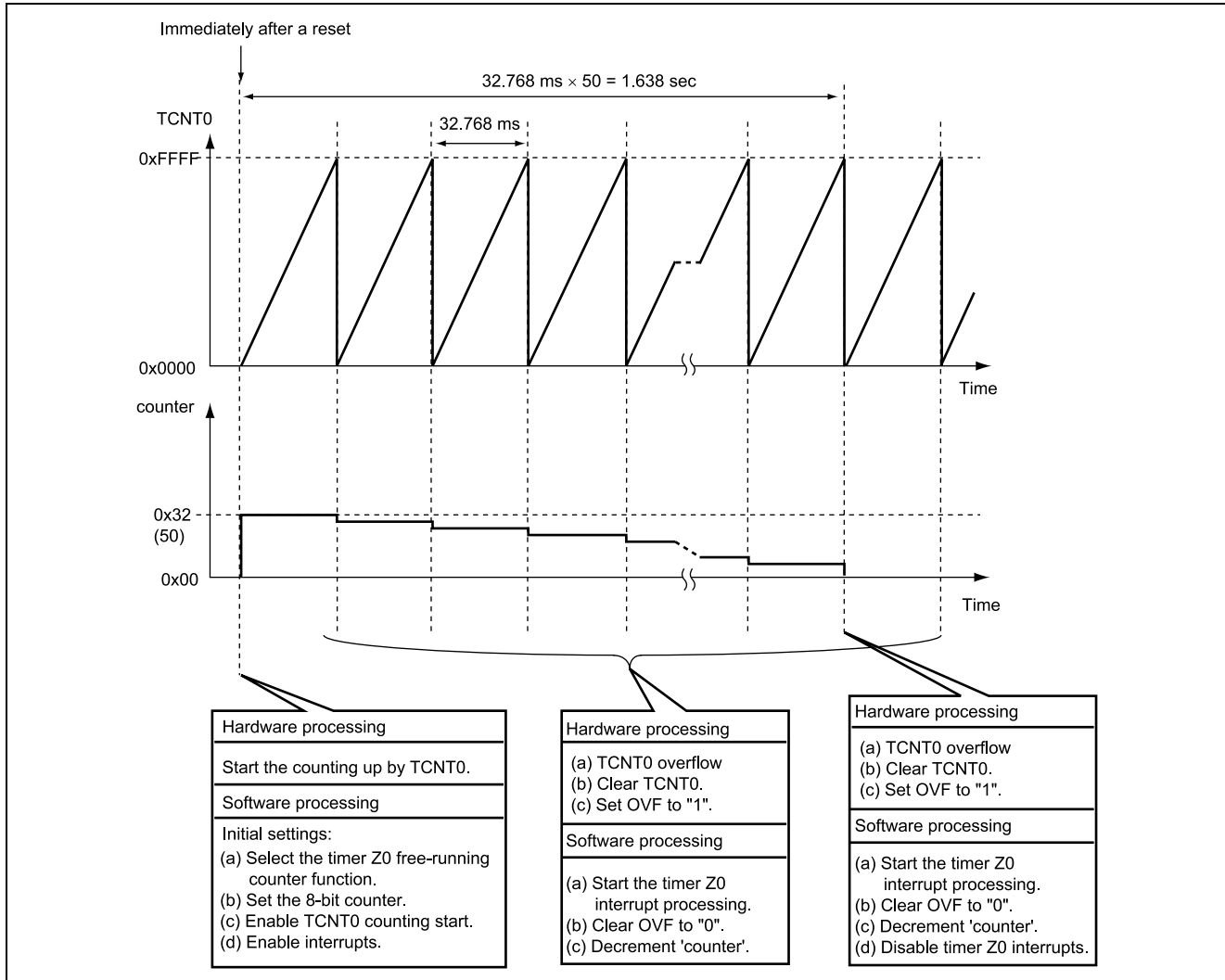


Figure 3.1 Principle of Operation

4. Description of Software

4.1 Modules

Table 4.1 describes the module used in this sample task.

Table 4.1 Description of Modules

Module Name	Label Name	Function
Main routine	main	Selects the timer Z0 free-running counter function, starts counting by TCNT0, and provides settings for interrupts.
Interrupt count	tz0int	Timer Z0 interrupt processing Decrements the 8-bit counter in RAM and disables timer Z0 interrupts when the counter reaches 0x00.

4.2 Arguments

This sample task uses no arguments.

4.3 Internal Registers

The internal registers used in this sample task are described below.

- TCR0 Timer control register 0 Address: 0xF700

Bit	Bit Name	Setting	Function
7	CCLR2	CCLR2 = 0	Counter clear 2 to 0
6	CCLR1	CCLR1 = 0	CCLR2 = 0, CCLR1 = 0, CCLR0 = 0: Disables clearing of TCNT0.
5	CCLR0	CCLR0 = 0	
4	CKEG1	CKEG1 = 0	Clock edge 1 to 0
3	CKEG0	CKEG0 = 0	CKEG1 = 0, CKEG = 0: Counts on the rising edge of the clock.
2	TPSC2	TPSC2 = 0	Clock select 2 to 0
1	TPSC1	TPSC1 = 1	TPSC2 = 0, TPSC1 = 1, TPSC0 = 1: Counts by an internal clock $\phi/8$.
0	TPSC0	TPSC0 = 1	

- TSR0 Timer status register 0 Address: 0xF703

Bit	Bit Name	Setting	Function
4	OVF	0	Overflow flag OVF = 0: Indicates that TCNT0 overflow has not occurred. OVF = 1: Indicates that TCNT0 overflow has occurred.

- TIER0 Timer interrupt enable register 0 Address: 0xF704

Bit	Bit Name	Setting	Function
4	OVIE	1	Timer overflow interrupt enable OVIE = 0: Disables interrupts by the OVF flag in TSR0. OVIE = 1: Enables interrupts by the OVF flag in TSR0.

- **TCNT0** Timer counter 0 Address: 0xF706
Function: An 8-bit up-counter that is incremented by clock input of system clock/8.
Setting: 0x0000

- **TSTR** Timer start register Address: 0xF720

Bit	Bit Name	Setting	Function
0	STR0	0	Channel 0 counter start STR0 = 0: Stops counting by TCNT0. STR0 = 1: Starts counting by TCNT0.

- **TMDR** Timer mode register Address: 0xF721

Bit	Bit Name	Setting	Function
0	SYNC	0	Timer synchronization SYNC = 0: TCNT0 operates independently of TCNT1. SYNC = 1: TCNT0 operates synchronously with TCNT1.

4.4 Description of RAM

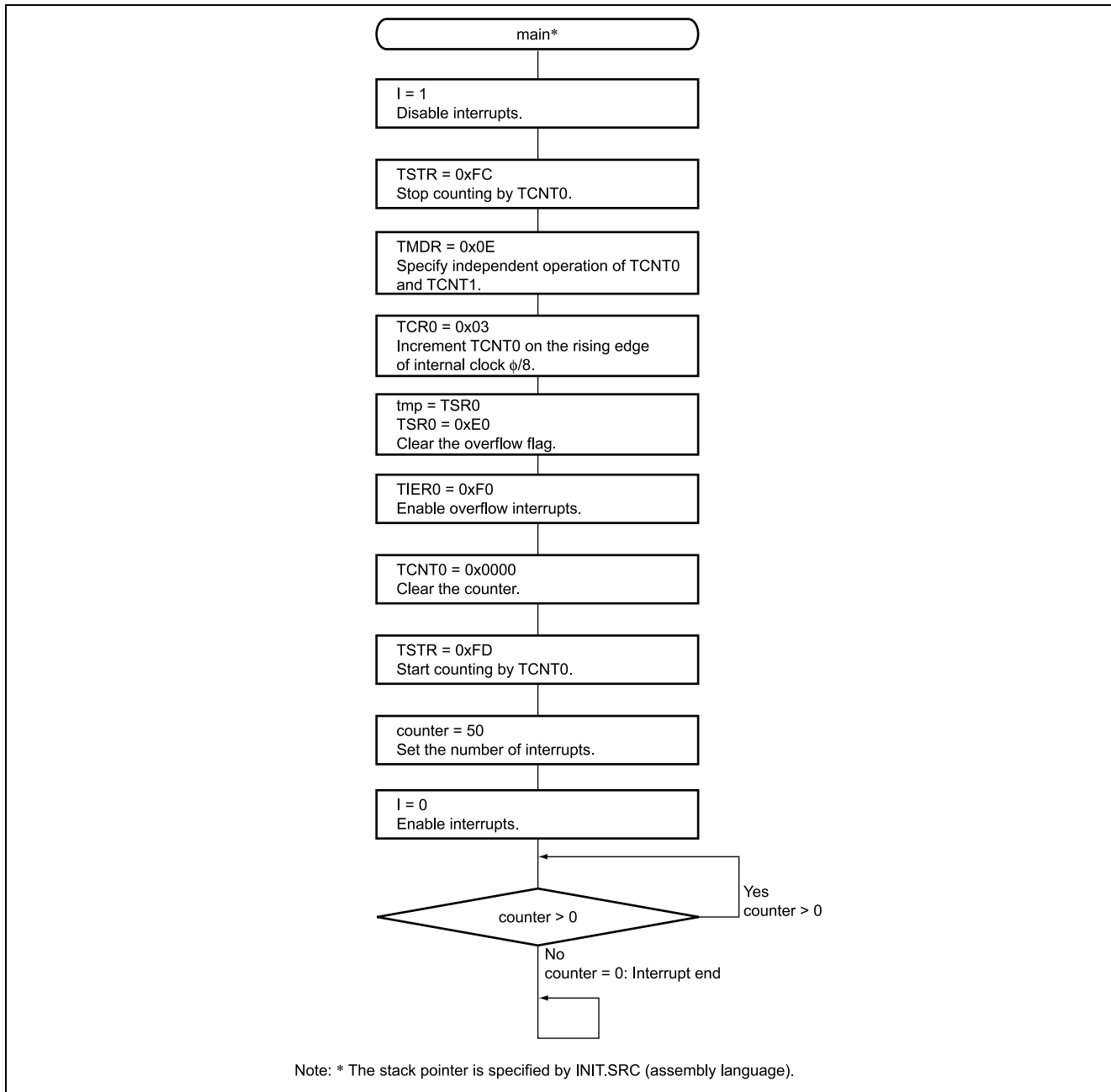
Table 4.2 describes the RAM used in this sample task.

Table 4.2 Description of RAM

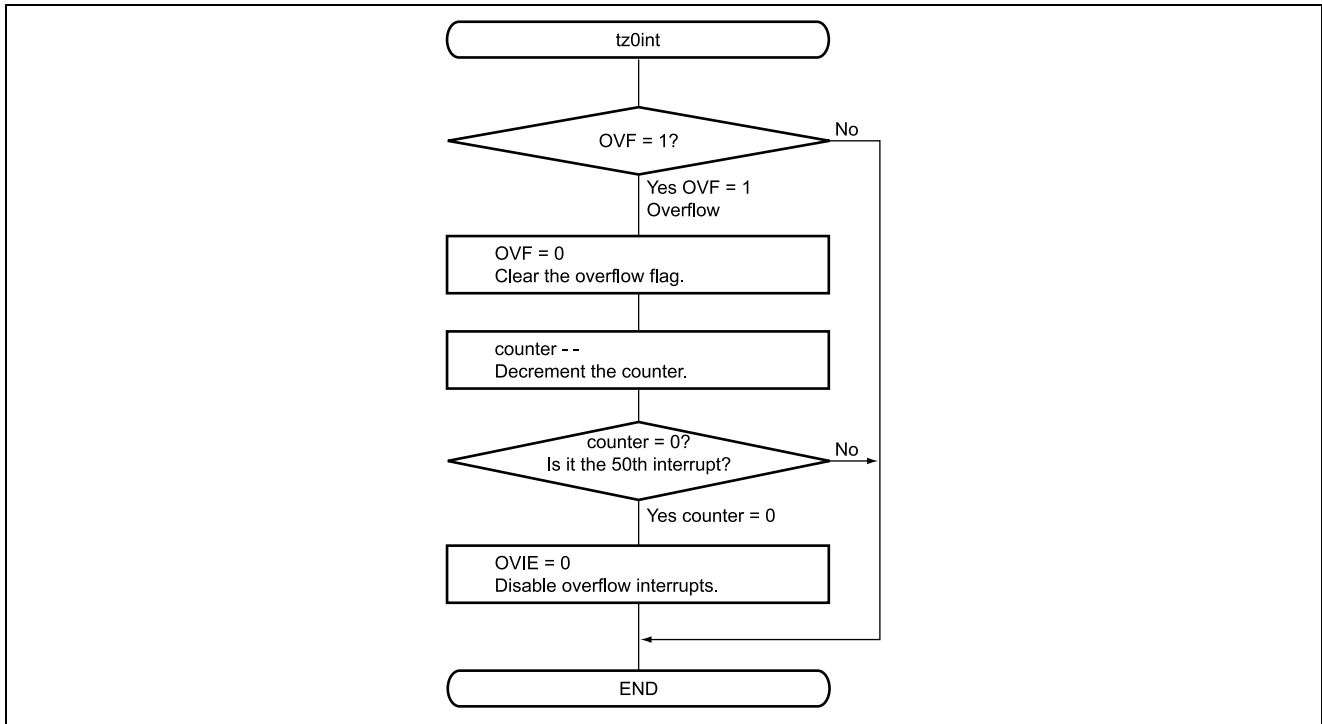
Label Name	Function	Size	Used in
counter	An 8-bit counter that counts the number of timer Z interrupts up to 50	1 byte	Main routine Interrupt count

5. Flowchart

1. Main routine



2. Interrupt count



6. Program List

```

/*****
/*
/* H8/300HN Series -H8/3687-
/* Application Note
/*
/* 'Interrupt Counting by 16bit Free Running Function'
/*
/* Function
/* : Timer Z 16bit Free Running Timer
/*
/* External Clock : 16MHz
/* Internal Clock : 16MHz
/* Sub Clock : 32.768kHz
/*
*****/

#include <machine.h>

/*****
/* Symbol Definition
*****/
struct BIT {
    unsigned char b7:1; /* bit7 */
    unsigned char b6:1; /* bit6 */
    unsigned char b5:1; /* bit5 */
    unsigned char b4:1; /* bit4 */
    unsigned char b3:1; /* bit3 */
    unsigned char b2:1; /* bit2 */
    unsigned char b1:1; /* bit1 */
    unsigned char b0:1; /* bit0 */
};

#define TCR0 *(volatile unsigned char *)0xF700 /* Timer control register_0 */
#define TSR0 *(volatile unsigned char *)0xF703 /* Timer status register_0 */
#define TSR0_BIT (*(struct BIT *)0xF703) /* Timer status register_0 */
#define OVF TSR0_BIT.b4 /* Overflow Flag */
#define TIER0 *(volatile unsigned char *)0xF704 /* Timer interrupt enable register0 */
#define TIER0_BIT (*(struct BIT *)0xF704) /* Timer interrupt enable register0 */
#define OVIE TIER0_BIT.b4 /* Overflow Interrupt Enable */
#define TCNT0 *(volatile unsigned short *)0xF706 /* Timer counter_0 */
#define TSTR *(volatile unsigned char *)0xF720 /* Timer start register */
#define TMDR *(volatile unsigned char *)0xF721 /* Timer mode register */

#pragma interrupt (tz0int)
/*****
/* Function define
*****/
extern void INIT ( void ); /* SP Set */
void main ( void );
void tz0int ( void );

```

```

/*****
/*   RAM define
/*****
volatile unsigned char  counter;                /* 8bit Counter
*/

/*****
/*   Vector Address
/*****
#pragma section      V1                /* VECTOR SECTOIN SET
*/
void (*const VEC_TBL1[])(void) = {
    INIT                                /* 00 Reset
*/
};
#pragma section      V2                /* VECTOR SECTOIN SET
*/
void (*const VEC_TBL2[])(void) = {
    tz0int                               /* 34 Timer Z0 Interrupt
*/
};

#pragma section                /* P
*/

/*****
/*   Main Program
/*****
void main ( void )
{
    unsigned char tmp;

    set_imask_ccr(1);                /* Interrupt Disable
*/

    TSTR = 0xFC;                    /* TCNT0 count stop
*/
    TMDR = 0x0E;                    /* TCNT0,TCNT1 Single Mode
*/
    TCR0 = 0x03;                    /* Rising edge, phi/8
*/
    tmp = TSR0;
    TSR0 = 0xE0;                    /* Interrupt Flag Clear
*/
    TIER0 = 0xF0;                    /* OVF Interrupt Enable
*/
    TCNT0 = 0x0000;                /* Clear TCNT0
*/
    TSTR = 0xFD;                    /* TCNT0 count start
*/
    counter = 50;

    set_imask_ccr(0);                /* Interrupt Enable
*/
    while(counter > 0);

    while(1);
}

/*****
/*   Timer Z0 Interrupt
/*****
void tz0int ( void )
{
    unsigned char tmp;

    if(OVF == 1){                    /* Overflow ?
*/
        OVF = 0;                    /* Clear Overflow Flag
*/
        counter--;                    /* counter decrement
*/
        if(counter == 0x00){
            OVIE = 0;                /* Overflow Interrupt Disable
*/
        }
    }
}

```

Link address specifications

Section Name	Address
CV1	0x0000
CV2	0x0034
P	0x0100
B	0xFB80

Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Sep.29.03	—	First edition issued

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